



DISCRIPTION

FEATURES

Molded construction Heat Resistance Molded Resin Excellent Mechanical Strength Excellent Solderability High Reliability Low Profile

OPTIONS

Tape & Reel is Standard (Qty: 5000 Pcs) Bulk Packing Available for smaller quantites Tolerance: J = 5% and K=10% is Standard, tighter Tolerance available (MOQ on request)

APPLICATIONS

VCRs DC/DC Converts Video Cameras CTV, VCR HIC Communication System Automotive Systems LCD/PDP Televisions Hard Disk Drives Network Systems Computer Peripheral Equipment

PHYSICAL CHARACTERISTICS

- Testing : (Equivalents acceptable) Inductance : HP4285A RDC : QuadTech 1880 m Ω Q : HP4342A SRF : HP4291A
- IDC Max : Determined when superimosed DC current is decreased 10% against it's initial value
- Operating Temperature : -25°C ~ +105°C
- Storage Temperature : -40°C ~ +105°C
- Solder methods : Vapor Phase, Infrared
- Resistance to soldering heat : 260°C for 10 seconds
- Solvent resistance : Conforms to MIL-STD-202E
- Marking : Inductance & Tolercane

ELECTRICAL SPECIFICATIONS

| Properties | Test conditions | | Value | Unit | Tol. |
|--------------------|-----------------|----------|-------|------|------------|
| Inductance | | L | 150 | μH | see Site 2 |
| Q factor | | Q | 40 | | min. |
| DC-resistance | | DCR typ. | | Ω | typ. |
| DC-resistance | | DCR max. | 9,0 | Ω | max. |
| Self-Res. Freq. | | SRF | 5 | Mhz | min. |
| Test-Freq. | | | 0,796 | Mhz | |
| Rated Current | | IDC | 105 | mA | max. |
| Saturation Current | | Isat | | mA | typ. |

| I. This electronic component is meant to be used in general electronic equipment. Before the incorporation of this component into any equipment with higher and more reliable requirements such as aviation, aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon | | | | | | SMT WOUND MOLDED CHIP INDUCTORS | | |
|--|-------|-------|-------|---------------------|---------|------------------------------------|-----|------------|
| -Components must be informed before the stage of design-in. Evaluation checks for safety have to be performed on each electronic components used in electrical circuits that require high safety and reliability | | | | | | Part No.: | S14 | 4003-151 |
| penormed on ea | | funct | | at require high san | | Customer: | | |
| DRW: | Chang | CHKD | Young | MATL: | Chu Chi | DATE | | 09.06.2009 |
| APPD: | Pong | | | FINISH | Vienna | Sheet | | 1 from 2 |

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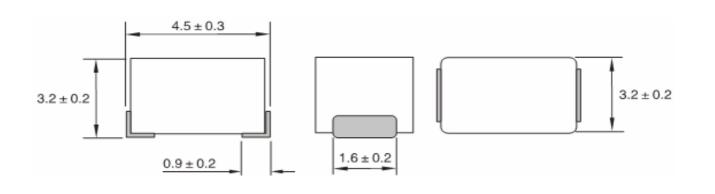
email: info@edcon-components.com





TECHNICAL INFORMATIONS

Dimensions (mm)

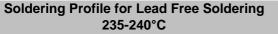


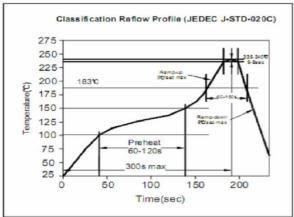
Ordering Information

Serie and Range

S14003-151

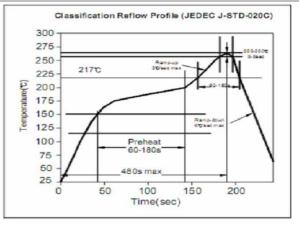
| Tolerance | ROHS | Packing | | | |
|----------------|-----------------|----------------|--|--|--|
| | | | | | |
| K | R | TR | | | |
| | | | | | |
| J = 5% | R = ROHS | BU = Bulk Ware | | | |
| K = 10% | N = non ROHS | TR = Tape Reel | | | |
| M = 20% | | | | | |
| N = 30% | | | | | |





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Soldering Profile for Lead Free Soldering 255-260°C



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